



# **Modeling of Natural Convection in Electronic Enclosures**

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# Outline

- Introduction and problem description
- Model development
- Numerical simulations
- Validation
- Summary

# Introduction

- Current design practice for sealed electronic enclosures
  - Numerical CFD simulations
  - Experimental prototype testing
  - Time consuming, expensive
- Analytically-based modeling
  - Quick, easy to implement
  - Ideal for preliminary design, parametric studies
- Objective: *to develop and validate a natural convection model for simple, sealed enclosures*
  - Vertical rectangular flat plate at center of a cuboid shaped enclosure
  - Full range of Rayleigh number from laminar natural convection to conduction

# Problem Description

- Enclosure dimensions

$$\frac{L_o}{L_i}, \quad \frac{L_i}{W_i}, \quad \frac{L_o}{W_o}, \quad \frac{b}{L_o}$$

- Isothermal boundary conditions

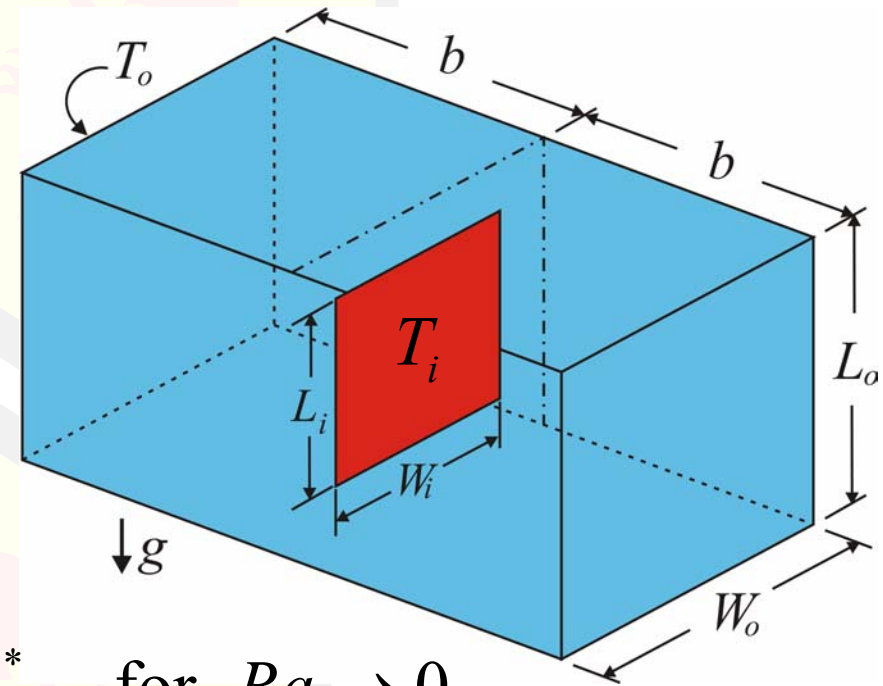
$$T_i > T_o$$

- Total heat transfer rate

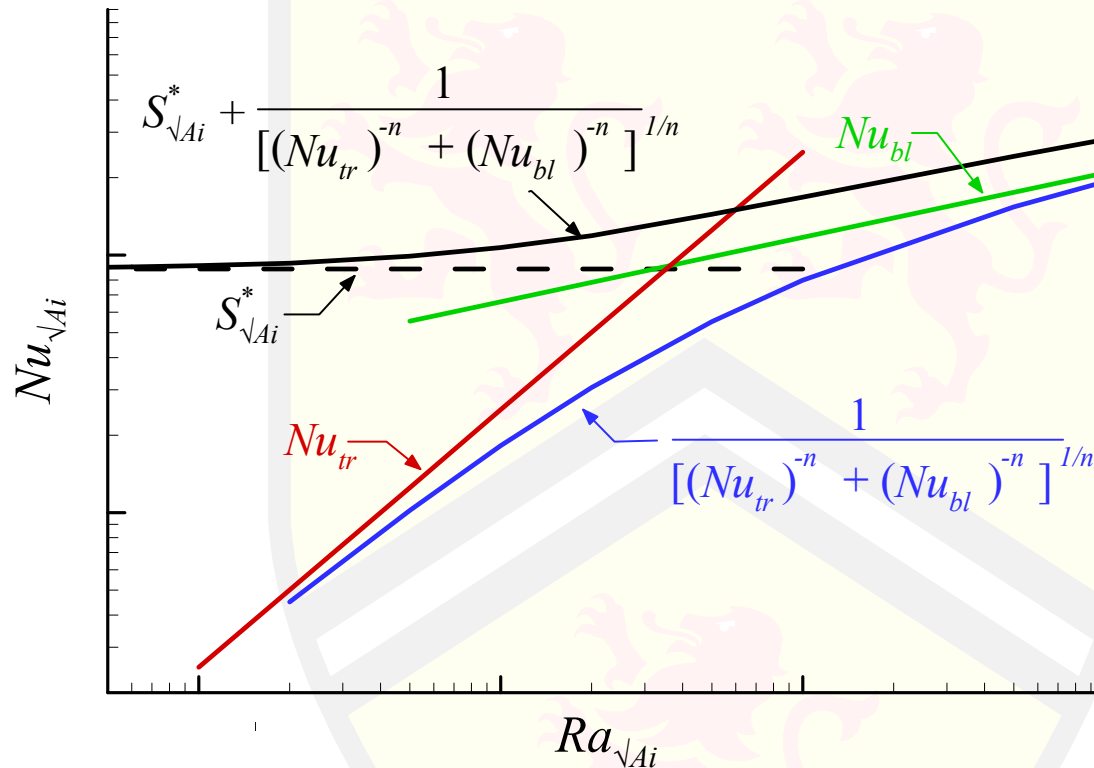
$$Nu_{\sqrt{A_i}} = \frac{Q}{k\sqrt{A_i}(T_i - T_o)} = S_{\sqrt{A_i}}^* \text{ for } Ra \rightarrow 0$$

- Rayleigh number

$$Ra_{\sqrt{A_i}} = \frac{g \beta (T_i - T_o) (\sqrt{A_i})^3}{\nu \alpha}$$



# General Model Formulation



- Combination of three asymptotic solutions (Teertstra, 2003)

$$Nu_{\sqrt{A_i}} = S_{\sqrt{A_i}}^* + \left[ \left( \frac{1}{Nu_{tr}} \right)^2 + \left( \frac{1}{Nu_{bl}} \right)^2 \right]^{-1/2}$$

$S_{\sqrt{A_i}}^* =$  conduction shape factor  
 $Nu_{tr} =$  transition flow convection  
 $Nu_{bl} =$  laminar boundary layer flow convection

# Conduction Shape Factor

- Composite model (Churchill and Usagi, 1972)

$$S_{\sqrt{A_i}}^* = \left[ \left( S_{b/L \rightarrow 0}^* \right)^{3/2} + \left( S_{b/L \rightarrow \infty}^* \right)^{3/2} \right]^{2/3}$$

- $b/L \rightarrow 0$  one dimensional conduction in gap

$$S = \frac{A_i}{b} \quad S_{b/L \rightarrow 0}^* = \frac{S}{\sqrt{A_i}} = \frac{\sqrt{A_i}}{b}$$

- $b/L \rightarrow \infty$  shape factor independent of  $b/L$

$$S_{b/L \rightarrow \infty}^* = \frac{1}{k \sqrt{A_i} R} \quad R = R_{plate} - R_{sphere}$$

$R_{plate}$  = isothermal flat plate in full space region

$R_{sphere}$  = equivalent sphere in full space region

$$d_{eff} = (L_o + W_o)/2$$

# Laminar Boundary Layer

- Assumptions
  - $T_b$  uniform
  - Non-intersecting boundary layers
- Series combination of resistances

$$R_{conv} = R_i + R_o \quad Nu_{bl} = \frac{1}{k\sqrt{A_i}} \frac{1}{R_{conv}} = \frac{1}{k\sqrt{A_i}} \frac{(1/R_i)}{(1 + R_o/R_i)}$$

$$R_i = \frac{T_i - T_b}{Q} = \frac{1}{k\sqrt{A_i}} \frac{1}{Nu_i} \quad R_o = \frac{T_b - T_o}{Q} = \frac{1}{k\sqrt{A_o}} \frac{1}{Nu_o}$$

- Convection at boundaries modeled using Lee, Yovanovich and Jafarpur (1991)

$$Nu_{\sqrt{A}} = F(\text{Pr}) G_{\sqrt{A}} Ra_{\sqrt{A}}^{1/4}$$

# Laminar Boundary Layer

$$Nu_{bl} = \frac{F(\text{Pr}) G_{\sqrt{A_i}} Ra_{\sqrt{A_i}}^{1/4}}{\left[ 1 + \left( \frac{A_i}{A_o} \right)^{7/10} \left( \frac{G_{\sqrt{A_i}}}{G_{\sqrt{A_o}}} \right)^{4/5} \right]^{5/4}}$$

- Prandtl number function  $F(\text{Pr}) = 0.513$  for air at STP
- Body gravity functions

$$G_{\sqrt{A_i}} = 2^{1/8} (W_i/L_i)^{1/8} \quad (\text{Lee et al., 1991})$$

$$G_{\sqrt{A_o}} = 2^{1/8} \left[ \frac{0.625(2b)^{4/3} W_o + L_o (2b + W_o)^{4/3}}{(L_o W_o + 2b(L_o + W_o))^{7/6}} \right]^{3/4}$$

(Jafarpur and Yovanovich, 1993)



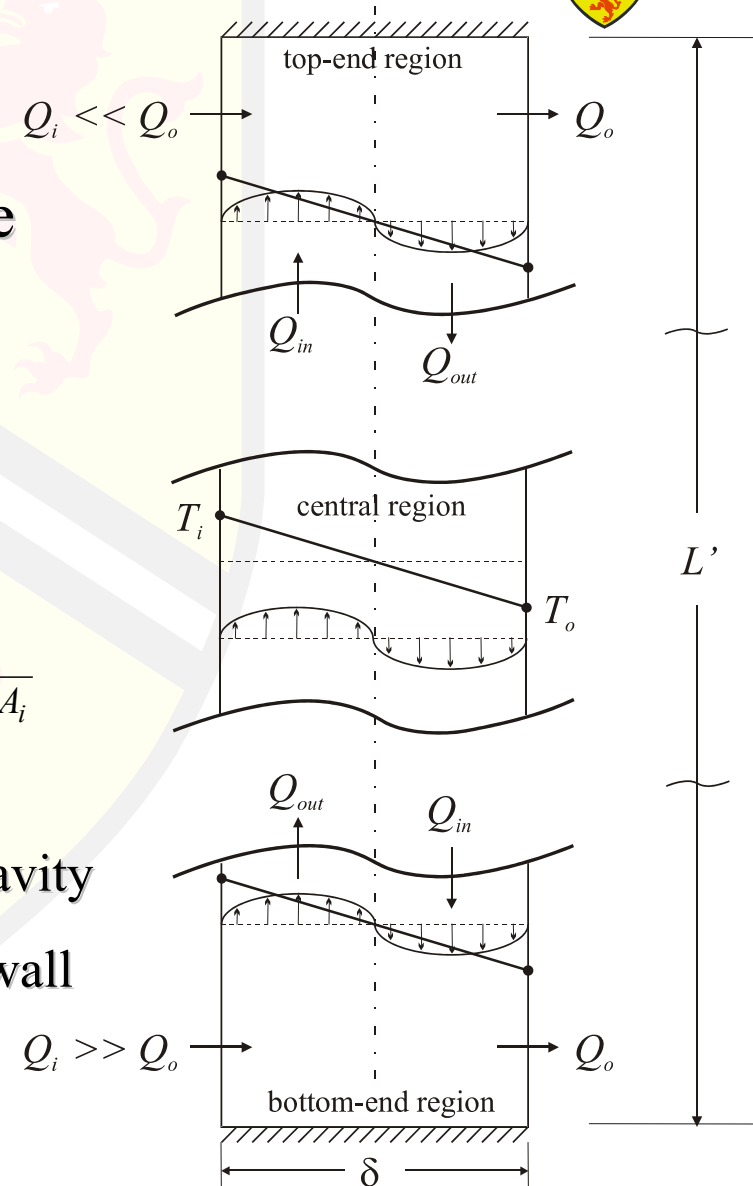
# Transition Flow

- Boundary layers merge at low Rayleigh numbers
- Linear temperature distribution in core
- Convective heat transfer in top and bottom recirculation regions
- Enthalpy balance in end regions

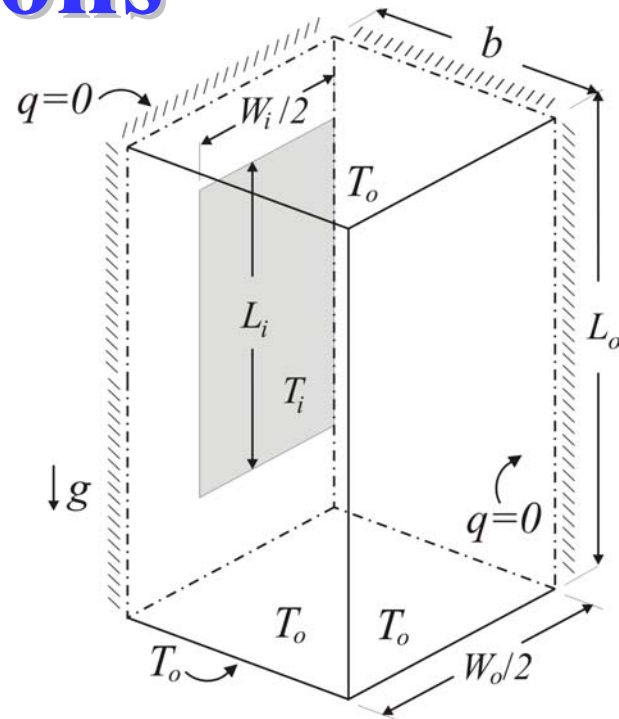
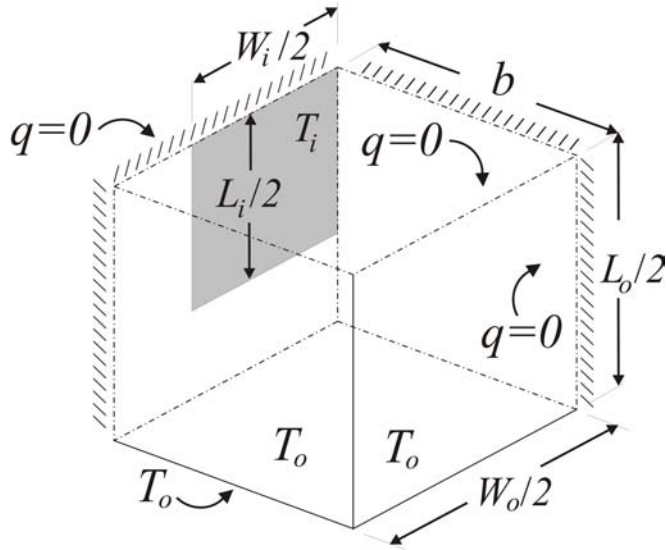
$$Nu_{tr} = \frac{\sqrt{2}}{360} \frac{\sqrt{W_i/L_i}}{(1 + L_o/L_i)} \left( \frac{\delta_{eff}}{\sqrt{A_i}} \right)^3 Ra \sqrt{A_i}$$

$\delta_{eff}$  = gap spacing of equivalent spherical cavity

$L_o, L_i$  = effective flow length on outer, inner wall



# Numerical Simulations



- Conduction shape factor

- Flotherm simulations of 56 enclosure geometries

$$T_i = 40^\circ C \quad T_o = 20^\circ C$$

$$L_o / L_i = 1.05, 1.2, 1.6, 2$$

$$L_i / W_i = L_o / W_o = 0.5, 1, 2$$

$$9 \quad b / L_o = 1 \rightarrow 0.05$$

- Natural convection

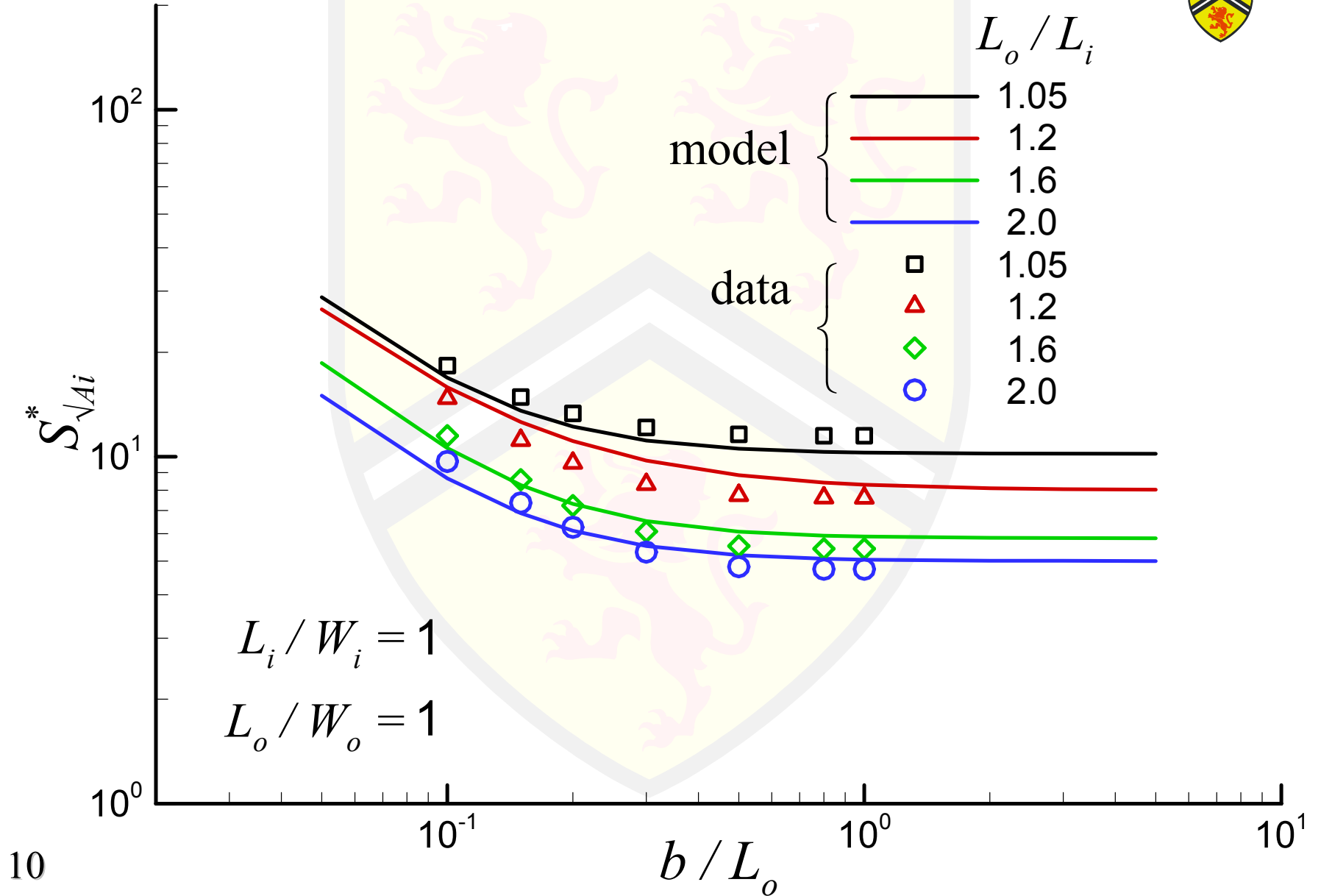
- Icepak simulations of 42 enclosure geometries

$$L_o / L_i = 1.05, 1.2, 1.6, 2$$

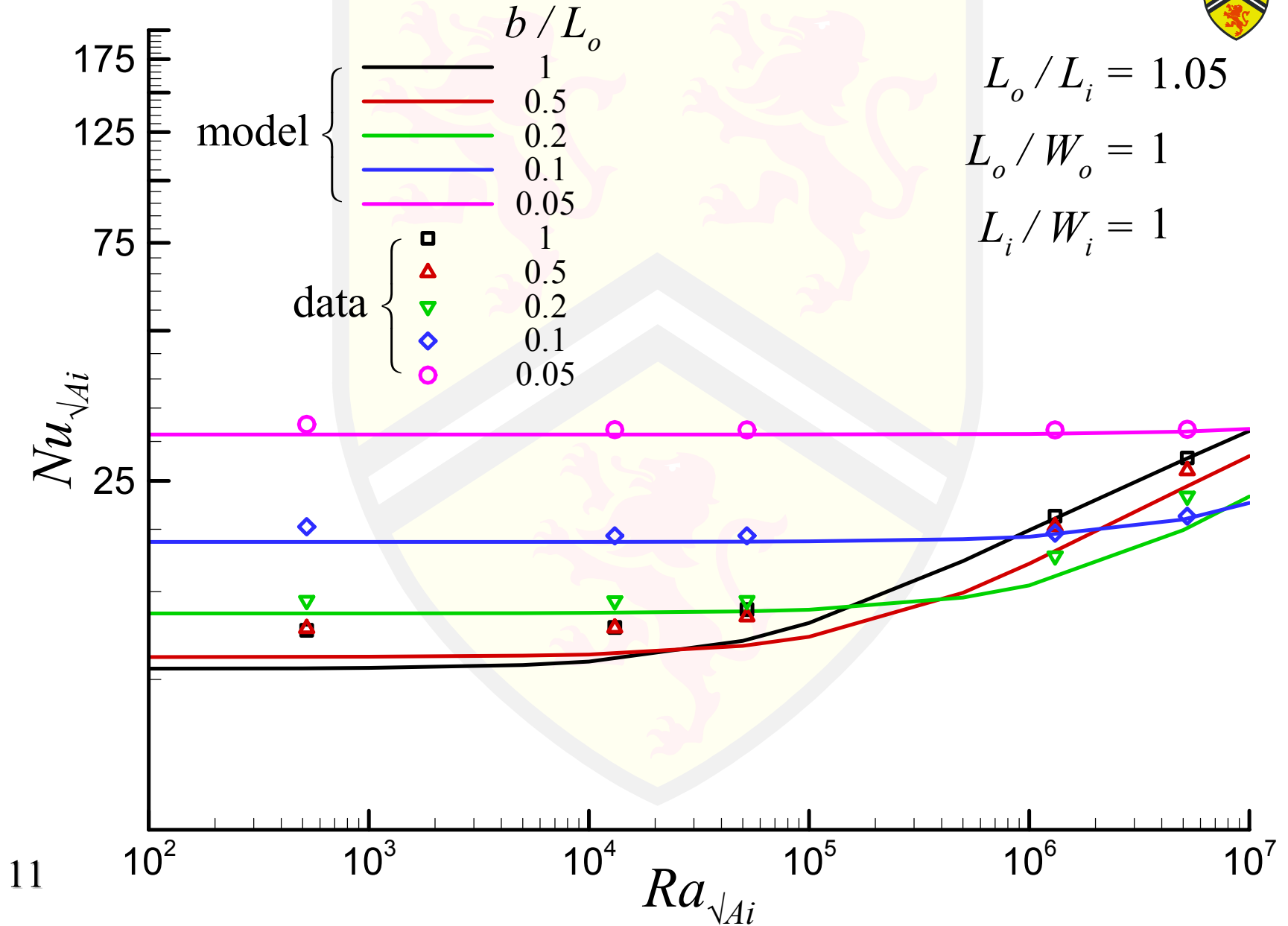
$$L_i / W_i = L_o / W_o = 1, 2$$

$$b / L_o = 1 \rightarrow 0.05$$

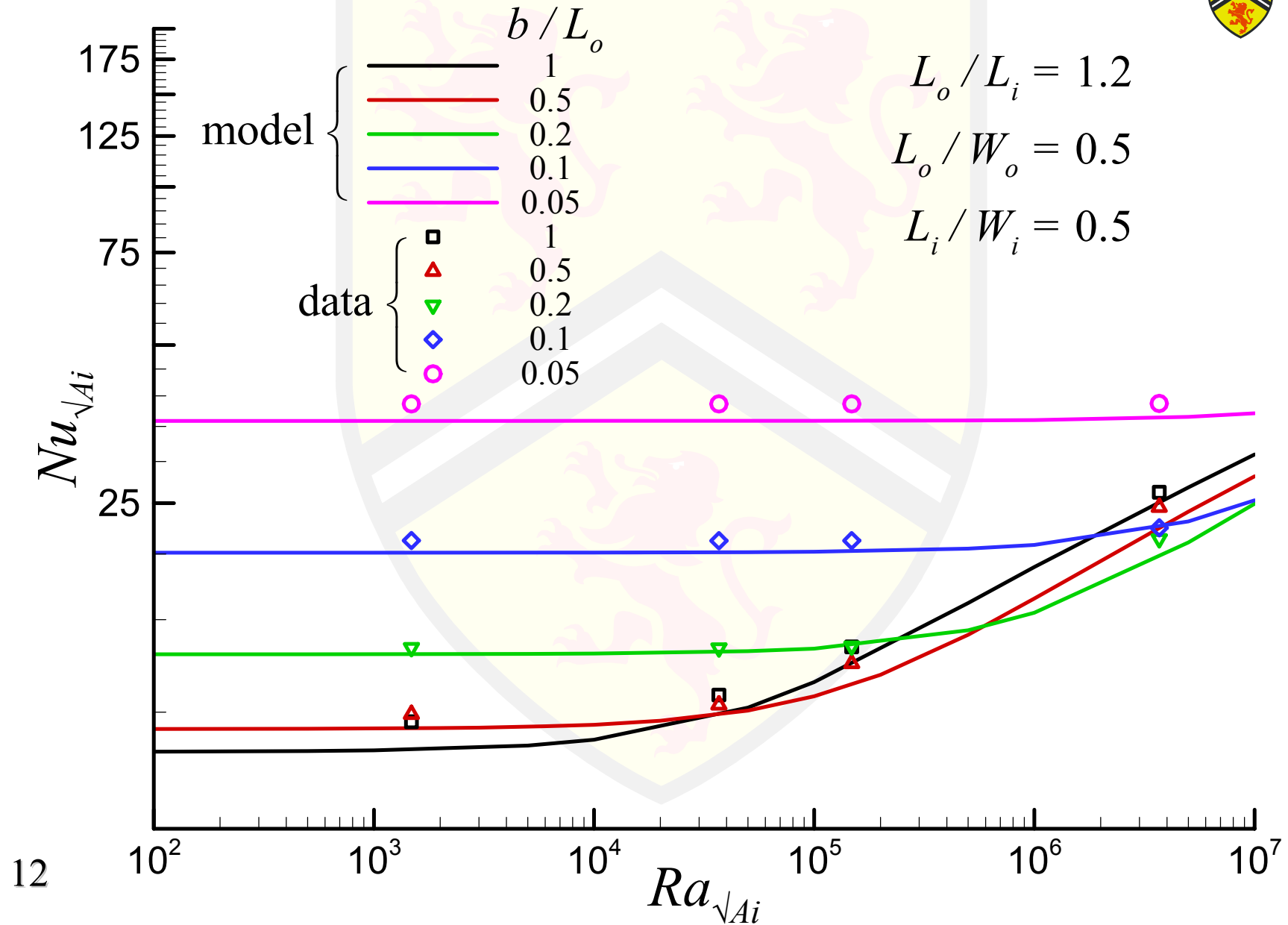
# Conduction Model Validation



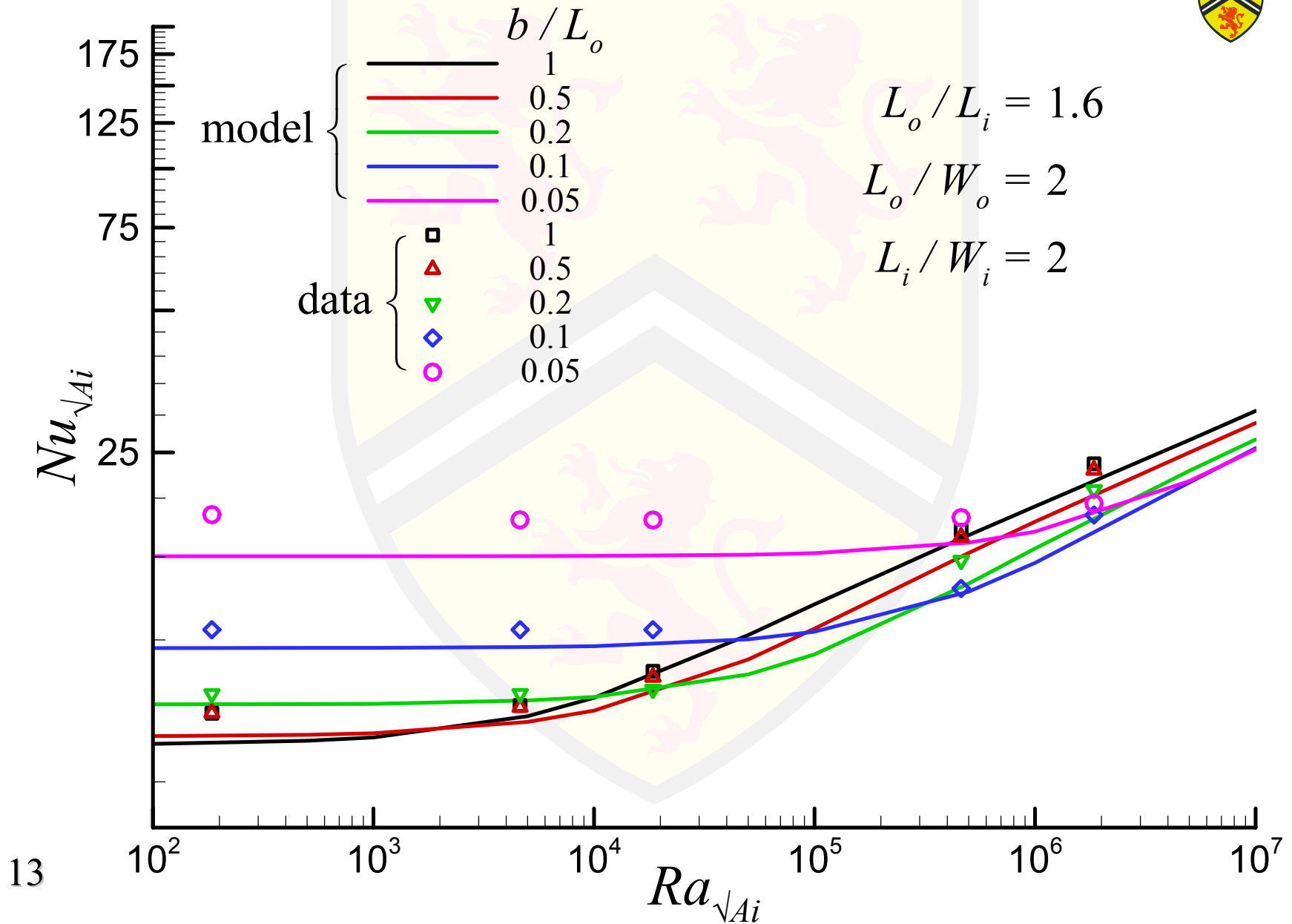
# Convection Model Validation



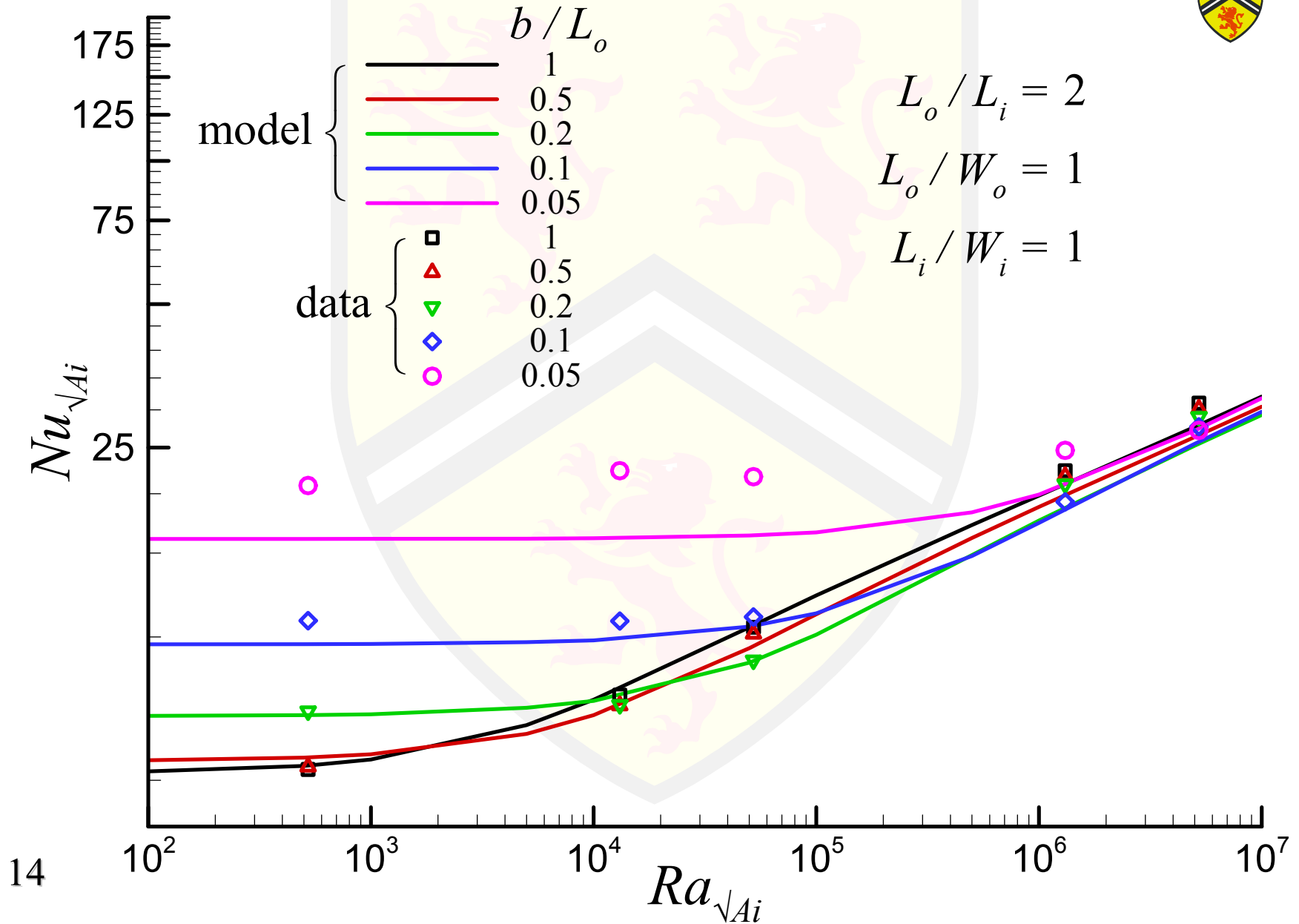
# Convection Model Validation



# Convection Model Validation



# Convection Model Validation



# Summary

- Analytical model developed for natural convection for a vertical plate in a sealed, cuboid shaped enclosure
- Validated with data from CFD simulations
  - 10 % average difference with numerical data
- Demonstrates trends in data as function of geometry and Rayleigh number
- Future work
  - Isoflux inner boundary condition
  - Array of vertical plates
  - Experimental validation of analytical models



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